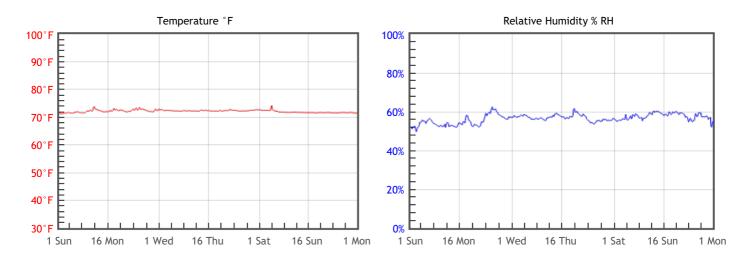
0_YUM_Textile_woskshop

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Preservation Environment Evaluation

Type of Decay	Risks & Metrics	Evaluation & General Comments		
Natural Aging Chemical decay of organic materials	RISK TWPI = 28	Accelerated rate of chemical decay in all organic materials due to the cumulative effects of temperature and humidity, with especially high risk for fast decaying organic materials such as acidic paper, color photographs and cellulosic plastics.		
Mechanical Damage Physical damage to hygroscopic materials	GOOD % DC = 0.16 % EMC min = 10 % EMC max = 10.6	Minimal risk of physical damage to most hygroscopic materials such as paintings, rare books and furniture.		
Mold Risk Mold growth in area or on collection objects	GOOD MRF = 0	Minimal risk of mold growth.		
Metal Corrosion Corrosion of metal components or objects	## RISK ## EMC max = 10.6	Heightened risk of metal corrosion due to extended periods of high levels of humidity.		

Graphs



Statistics

Temperature		Relative Humidity		Dew Point	
T°F Mean	72.2	%RH Mean	56	DP°F Mean	55.8
T°F Median	72.2	%RH Median	57	DP°F Median	55.9
T°F Stdev	0.5	%RH Stdev	2	DP°F Stdev	1.3
T°F Min	71.2	%RH Min	50	DP°F Min	51.6
T°F Max	76.6	%RH Max	65	DP°F Max	62.5